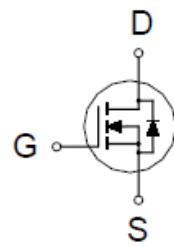


# P0603BEAD

## N-Channel Enhancement Mode MOSFET

### PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
30V	5.8mΩ @ $V_{GS} = 10V$	56A



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current <sup>1,2</sup>	$I_D$	56	A
		35	
		14.5	
		11.6	
		100	
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	38	mJ
Avalanche Current	$I_{AS}$	72	
Avalanche Energy	$E_{AS}$	31	
Power Dissipation	$P_D$	12	W
		2.1	
		1.3	
Operating Junction & Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

# P0603BEAD

## N-Channel Enhancement Mode MOSFET

### THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>3</sup>	$R_{\theta JA}$		60	$^{\circ}\text{C} / \text{W}$
Junction-to-Case	$R_{\theta JC}$		3.5	

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Package limitation current is 27A.

<sup>3</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz.Copper , in a still air environment with  $T_A=25^{\circ}\text{C}$ 。 The value in any given application depends on the user's specific board design.

### ELECTRICAL CHARACTERISTICS ( $T_J = 25^{\circ}\text{C}$ , Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})DSS}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	30			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	1.7	2.5	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$			1	$\mu\text{A}$
		$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, T_J = 55^{\circ}\text{C}$			10	
On-State Drain Current <sup>1</sup>	$I_{D(\text{ON})}$	$V_{DS} = 5\text{V}, V_{GS} = 10\text{V}$	100			A
Drain-Source On-State Resistance <sup>1</sup>	$R_{DS(\text{ON})}$	$V_{GS} = 4.5\text{V}, I_D = 20\text{A}$		8.8	10	$\text{m}\Omega$
		$V_{GS} = 10\text{V}, I_D = 20\text{A}$		5.4	5.8	
Forward Transconductance <sup>1</sup>	$g_{fs}$	$V_{DS} = 5\text{V}, I_D = 20\text{A}$		68		S
<b>DYNAMIC</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = 15\text{V}, f = 1\text{MHz}$		1540		pF
Output Capacitance	$C_{oss}$			256		
Reverse Transfer Capacitance	$C_{rss}$			207		
Gate Resistance	$R_g$	$V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$		1.6		$\Omega$
Total Gate Charge <sup>2</sup>	$Q_{g(VGS=10V)}$	$V_{DS} = 0.5V_{(\text{BR})DSS}, I_D = 20\text{A}, V_{GS}=10\text{V}$		35.3		nC
	$Q_{g(VGS=4.5V)}$			18.2		
Gate-Source Charge <sup>2</sup>	$Q_{gs}$			6.4		
Gate-Drain Charge <sup>2</sup>	$Q_{gd}$			9.5		
Turn-On Delay Time <sup>2</sup>	$t_{d(on)}$	$V_{DS} = 0.5V_{(\text{BR})DSS}, I_D \geq 20\text{A}, V_{GS} = 10\text{V}, R_{\text{GEN}} = 6\Omega$		31		nS
Rise Time <sup>2</sup>	$t_r$			18		
Turn-Off Delay Time <sup>2</sup>	$t_{d(off)}$			56		
Fall Time <sup>2</sup>	$t_f$			12		

# P0603BEAD

## N-Channel Enhancement Mode MOSFET

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS						
Continuous Current <sup>3</sup>	I <sub>S</sub>				56	A
Diode Forward Voltage <sup>1</sup>	V <sub>SD</sub>	I <sub>S</sub> = 20A, V <sub>GS</sub> = 0V			1.3	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 20A, dI <sub>F</sub> /dt = 100A / μS		21		nS
Reverse Recovery Charge	Q <sub>rr</sub>			8		nC

<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

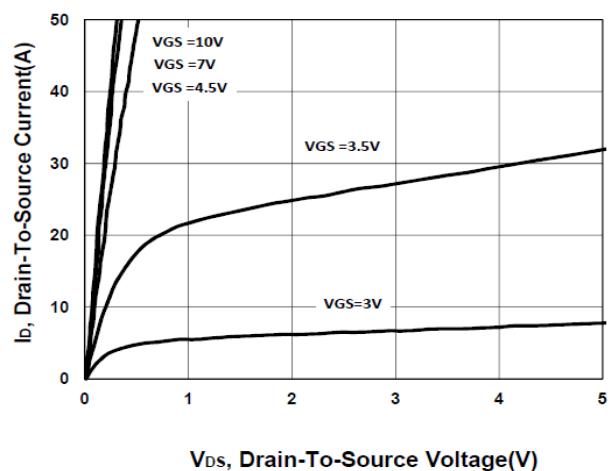
<sup>2</sup>Independent of operating temperature.

<sup>3</sup> Package limitation current is 27A.

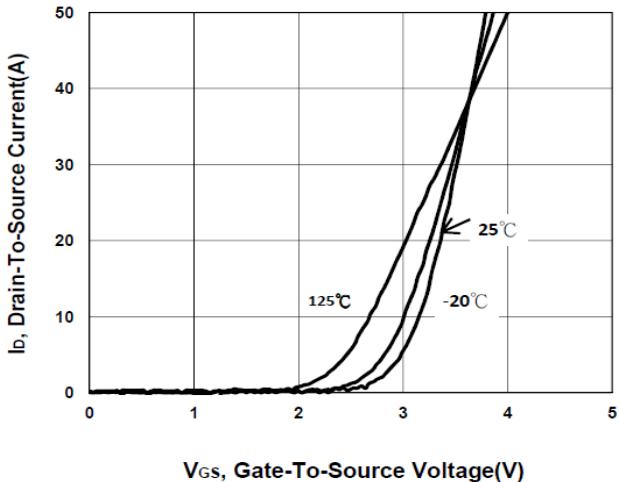
## P0603BEAD

### N-Channel Enhancement Mode MOSFET

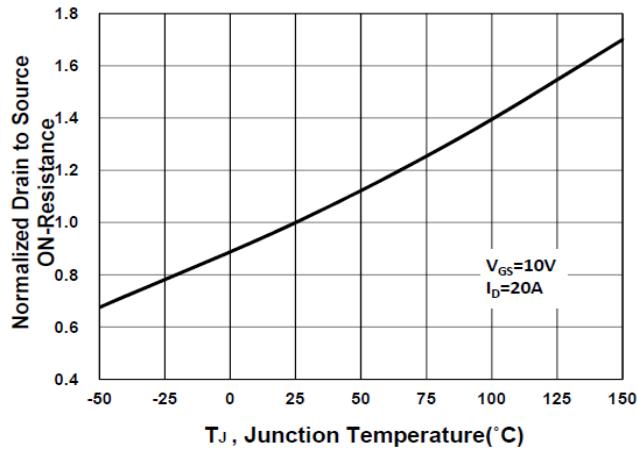
**Output Characteristics**



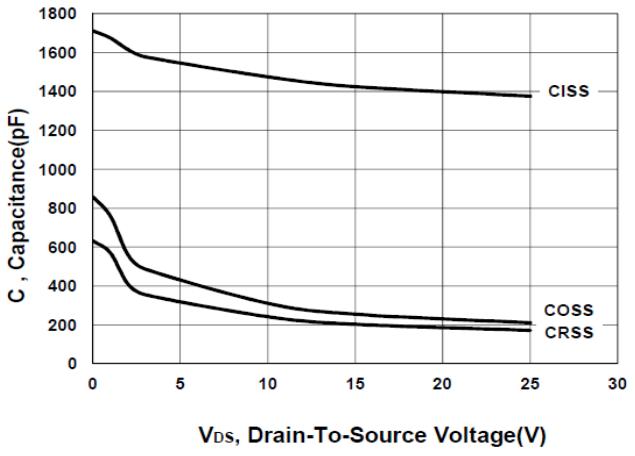
**Transfer Characteristics**



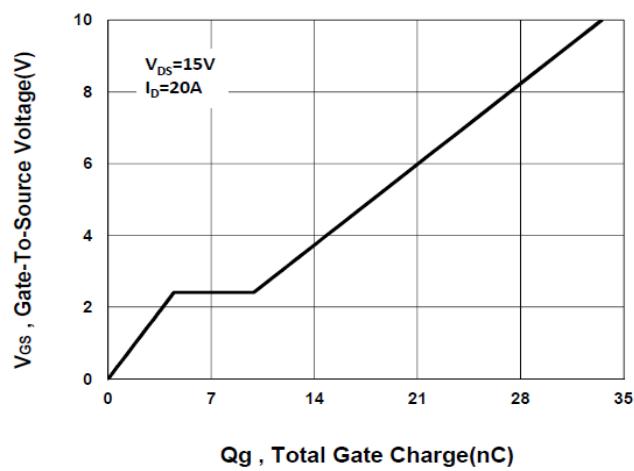
**On-Resistance VS Temperature**



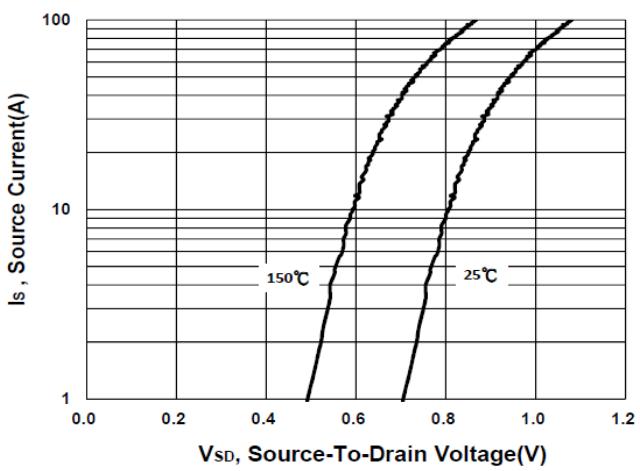
**Capacitance Characteristic**



**Gate charge Characteristics**

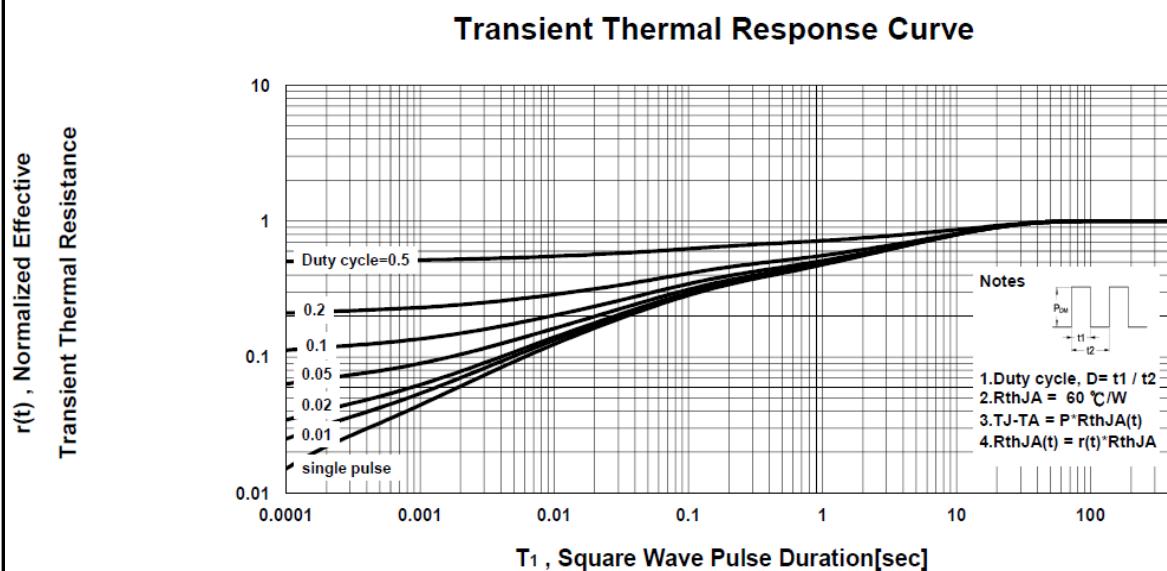
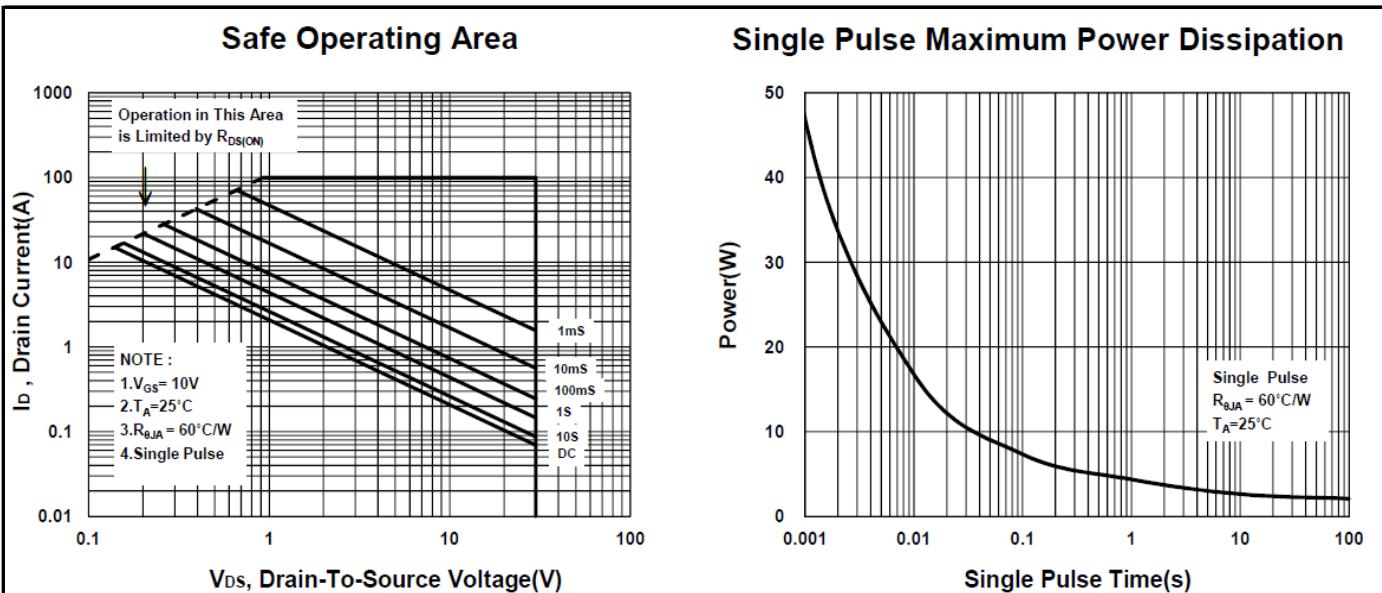


**Source-Drain Diode Forward Voltage**



## P0603BEAD

### N-Channel Enhancement Mode MOSFET



# P0603BEAD

## N-Channel Enhancement Mode MOSFET

### Package Dimension

### PDFN 3x3P MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	3		3.6	I	0.7		1.12
B	2.88		3.2	J	0.1		0.33
C	2.9		3.2	K	0.6		
D	1.98		2.69	L	0°	10°	12°
E	3		3.6	M	0.14		0.41
F	0		0.455	N	0.6		0.7
G	1.47		2.2	O	0.12		0.36
H	0.15		0.56	P	0		0.2

